

Insulated Gate Bi-Polar Transistor

Type T0900EB45A

Absolute Maximum Ratings

| | VOLTAGE RATINGS | MAXIMUM LIMITS | UNITS |
|----------------|--|----------------|-------|
| V_{CES} | Collector – emitter voltage | 4500 | V |
| $V_{DC\ link}$ | Permanent DC voltage for 100 FIT failure rate. | 2800 | V |
| V_{GES} | Peak gate – emitter voltage | ±20 | V |

| | RATINGS | MAXIMUM LIMITS | UNITS |
|----------------|--|----------------|------------|
| $I_{C(DC)}$ | DC collector current, IGBT | 900 | A |
| I_{CRM} | Repetitive peak collector current, $t_p=1ms$, IGBT | 1800 | A |
| $I_{F(DC)}$ | Continuous DC forward current, Diode | 900 | A |
| I_{FRM} | Repetitive peak forward current, $t_p=1ms$, Diode | 1800 | A |
| I_{FSM} | Peak non-repetitive surge $t_p=10ms$, $V_{RM}=60\%V_{RRM}$, Diode (Note 4) | 14.2 | A |
| I_{FSM2} | Peak non-repetitive surge $t_p=10ms$, $V_{RM}\leq 10V$, Diode (Note 4) | 15.6 | A |
| P_{MAX} | Maximum power dissipation, IGBT (Note 2) | 7.1 | kW |
| $(di/dt)_{cr}$ | Critical diode di/dt (note 3) | 2000 | A/ μs |
| T_j | Operating temperature range. | -40 to +125 | °C |
| T_{stg} | Storage temperature range. | -40 to +125 | °C |

Notes: -

- 1) Unless otherwise indicated $T_j = 125^\circ C$.
- 2) $T_{sink} = 25^\circ C$, double side cooled.
- 3) Maximum commutation loop inductance 200nH.
- 4) Half-sinewave, $125^\circ C$ T_j initial.

Characteristics

IGBT Characteristics

| | PARAMETER | MIN | TYP | MAX | TEST CONDITIONS | UNITS |
|---------------|--|-----|------|----------|---|------------|
| $V_{CE(sat)}$ | Collector – emitter saturation voltage | - | 2.8 | 3.2 | $I_C = 900A, V_{GE} = 15V, T_j = 25^\circ C$ | V |
| | | - | 3.6 | 4.0 | $I_C = 900A, V_{GE} = 15V$ | V |
| V_{T0} | Threshold voltage | - | - | 1.4 | Current range: 300 – 900A | V |
| r_T | Slope resistance | - | - | 2.9 | | m Ω |
| $V_{GE(TH)}$ | Gate threshold voltage | - | 5.2 | - | $V_{CE} = V_{GE}, I_C = 90mA$ | V |
| I_{CES} | Collector – emitter cut-off current | - | 15 | 35 | $V_{CE} = V_{CES}, V_{GE} = 0V$ | mA |
| I_{GES} | Gate leakage current | - | - | ± 10 | $V_{GE} = \pm 20V$ | μA |
| C_{ies} | Input capacitance | - | 140 | - | $V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$ | nF |
| $t_{d(on)}$ | Turn-on delay time | - | 1.7 | - | $I_C = 900A, V_{CE} = 2800V, di/dt = 1500A/\mu s$ | μs |
| $t_r(V)$ | Rise time | - | 3.5 | - | | μs |
| $Q_{g(on)}$ | Turn-on gate charge | - | 7 | - | $V_{GE} = \pm 15V, L_s = 200nH$ | μC |
| E_{on} | Turn-on energy | - | 6.3 | - | $R_{g(ON)} = 6\Omega, R_{g(OFF)} = 21\Omega, C_{GE} = 90nF$ | J |
| $t_{d(off)}$ | Turn-off delay time | - | 4.2 | - | Integral diode used as freewheel diode (Note 3 & 4) | μs |
| $t_f(I)$ | Fall time | - | 2.6 | - | | μs |
| $Q_{g(off)}$ | Turn-off gate charge | - | 8 | - | | μC |
| E_{off} | Turn-off energy | - | 4.3 | - | | J |
| I_{SC} | Short circuit current | - | 3000 | - | $V_{GE} = +15V, V_{CC} = 2800V, V_{CEmax} \leq V_{CES}, t_p \leq 10\mu s$ | A |

Diode Characteristics

| | PARAMETER | MIN | TYP | MAX | TEST CONDITIONS | UNITS |
|----------|----------------------------------|-----|------|------|--|------------|
| V_F | Forward voltage | - | 3.7 | 4.0 | $I_F = 900A, T_j = 25^\circ C$ | V |
| | | - | 3.9 | 4.2 | $I_F = 900A$ | V |
| V_{T0} | Threshold voltage | - | - | 2.27 | Current range 300-900A | V |
| r_T | Slope resistance | - | - | 2.15 | | m Ω |
| I_{rm} | Peak reverse recovery current | - | 800 | - | $I_F = 900A, V_{GE} = -15V, di/dt = 1500A/\mu s$ | A |
| Q_{rr} | Recovered charge | - | 1000 | - | | μC |
| t_{rr} | Reverse recovery time, 50% chord | - | 1.8 | - | | μs |
| E_r | Reverse recovery energy | - | 1.25 | - | | J |

Thermal Characteristics

| | PARAMETER | MIN | TYP | MAX | TEST CONDITIONS | UNITS |
|------------|--|-----|-----|-----|-----------------------|-------|
| R_{thJK} | Thermal resistance junction to sink, IGBT | - | - | 14 | Double side cooled | K/kW |
| | | - | - | 23 | Collector side cooled | K/kW |
| | | - | - | 37 | Emitter side cooled | K/kW |
| R_{thJK} | Thermal resistance junction to sink, Diode | - | - | 26 | Double side cooled | K/kW |
| | | - | - | 41 | Cathode side cooled | K/kW |
| | | - | - | 78 | Anode side cooled | K/kW |
| F | Mounting force | 25 | - | 35 | Note 2 | kN |
| W_t | Weight | - | 1.2 | - | | kg |

Notes:-

- 1) Unless otherwise indicated $T_j = 125^\circ C$.
- 2) Consult application note 2008AN01 for detailed mounting requirements
- 3) C_{GE} is additional gate – emitter capacitance added to output of gate drive
- 4) Figures 6 to 9 are obtained using integral diode as freewheeling diode

Curves

Figure 1 – Typical collector-emitter saturation voltage characteristics

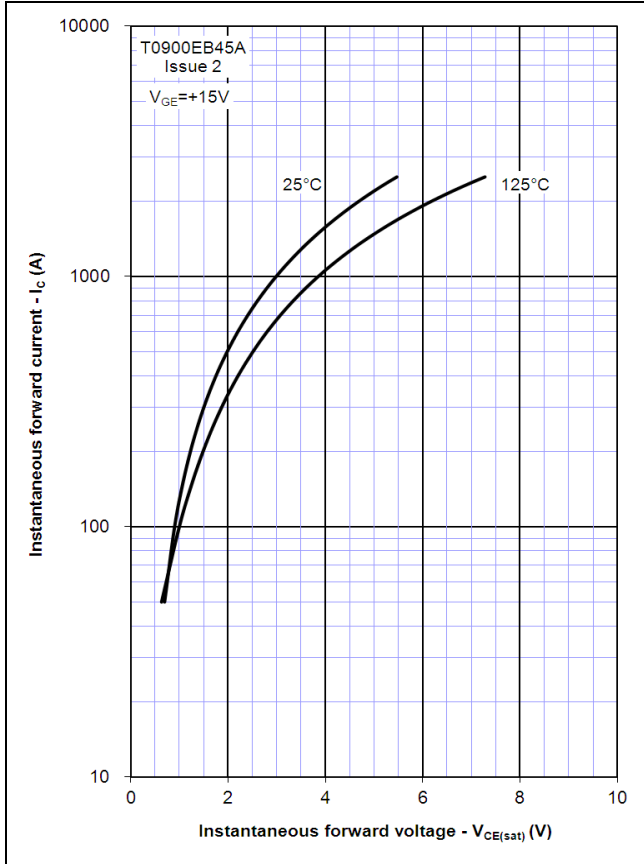


Figure 2 – Typical output characteristic

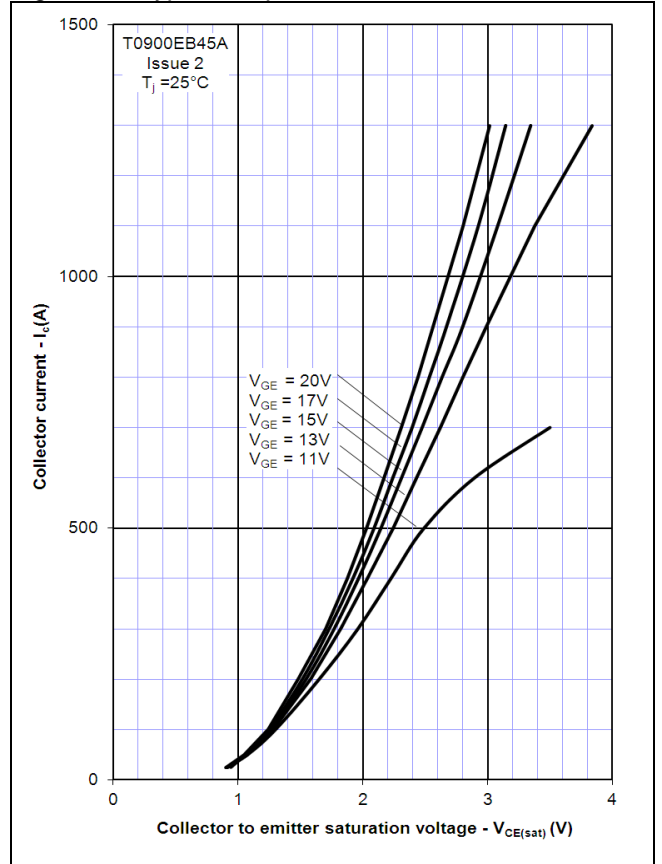


Figure 3 – Typical output characteristic

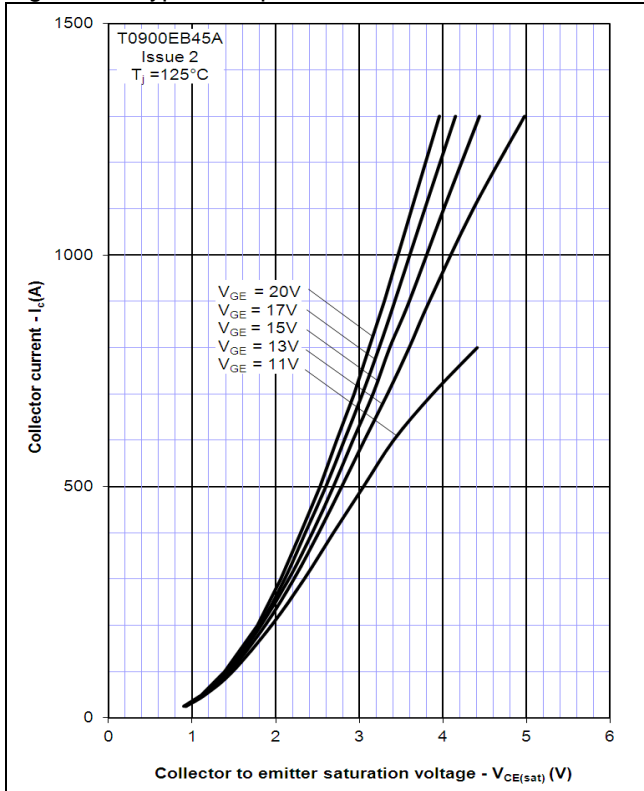


Figure 4 – Typical turn-on delay time vs gate resistance

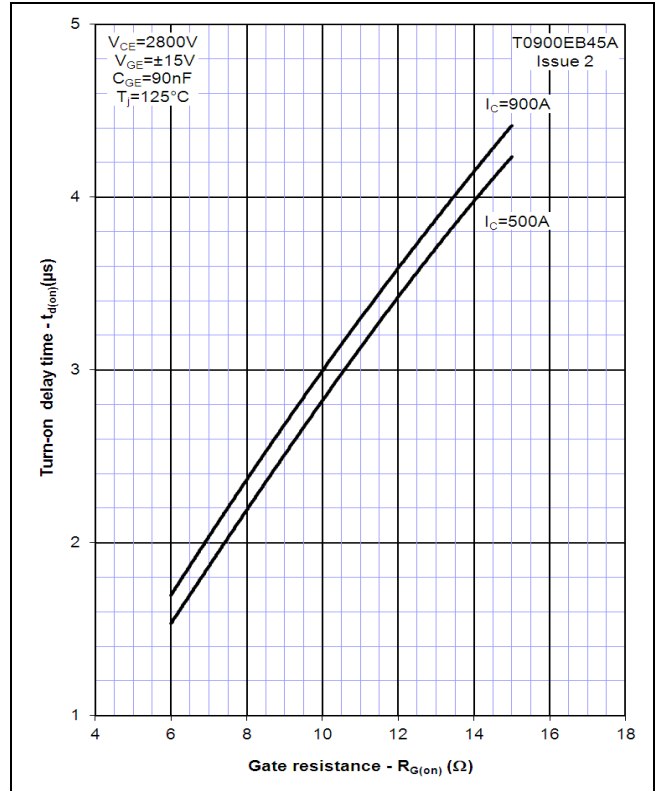


Figure 5 – Typical turn-off delay time vs. gate resistance

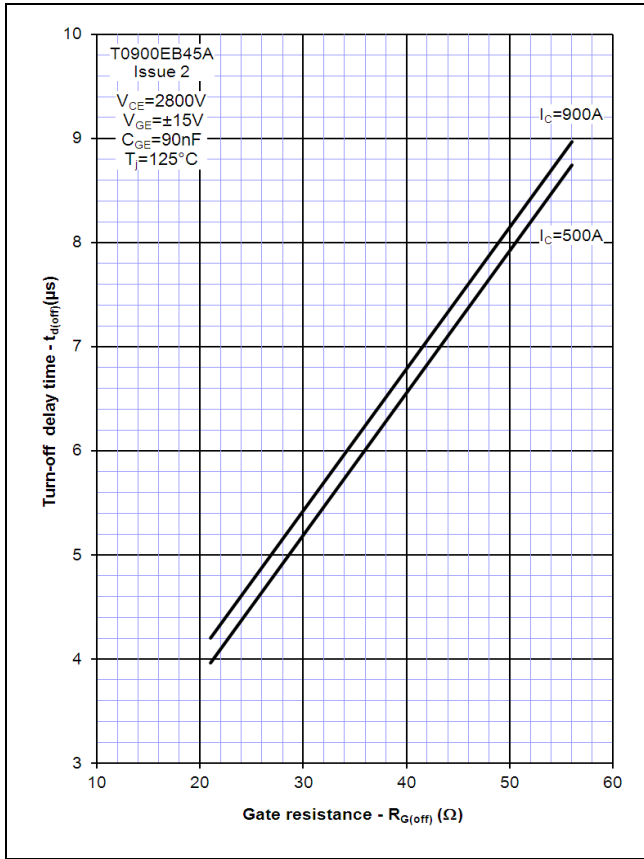


Figure 6 – Typical turn-on energy vs. collector current

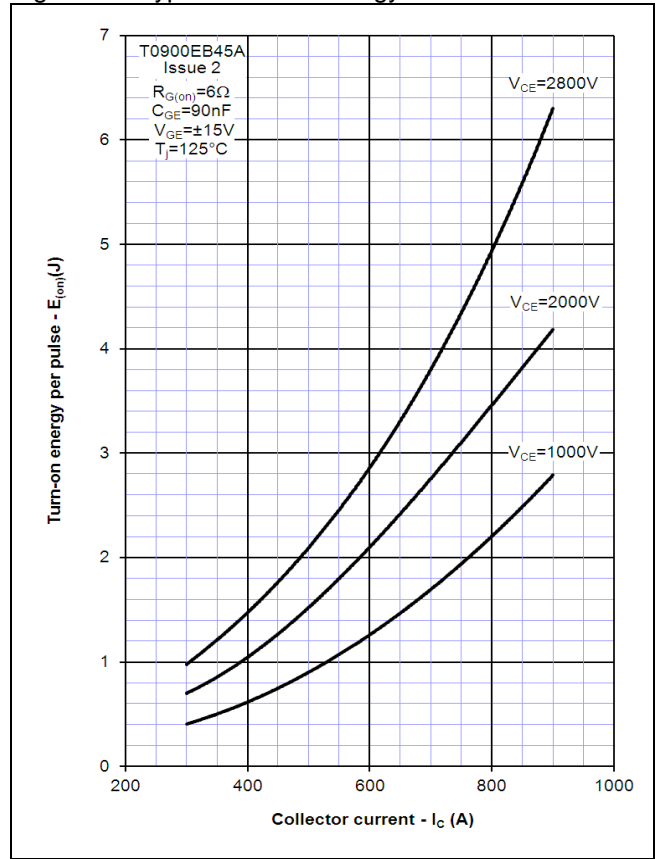


Figure 7 – Typical turn-on energy vs. di/dt

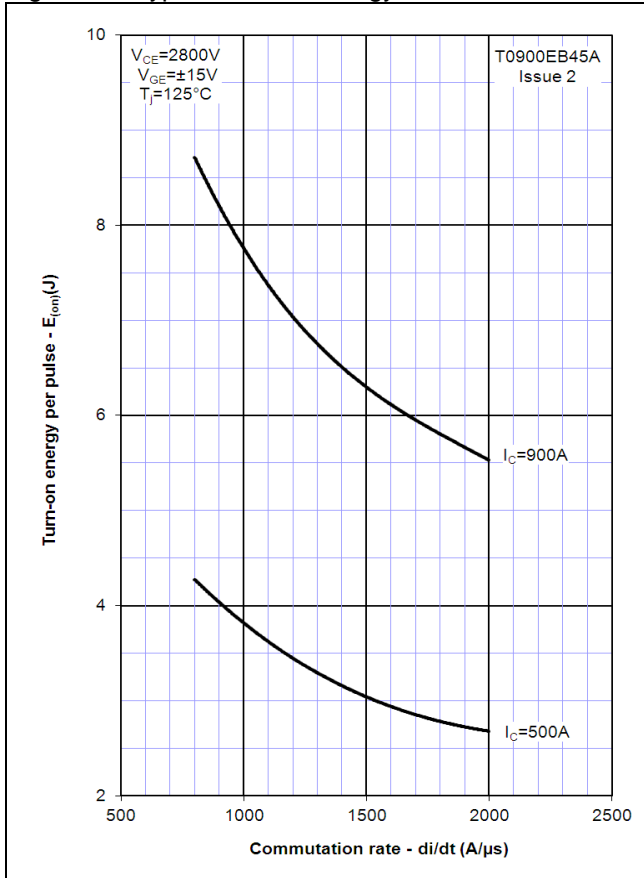


Figure 8 – Typical turn-off energy vs. collector current

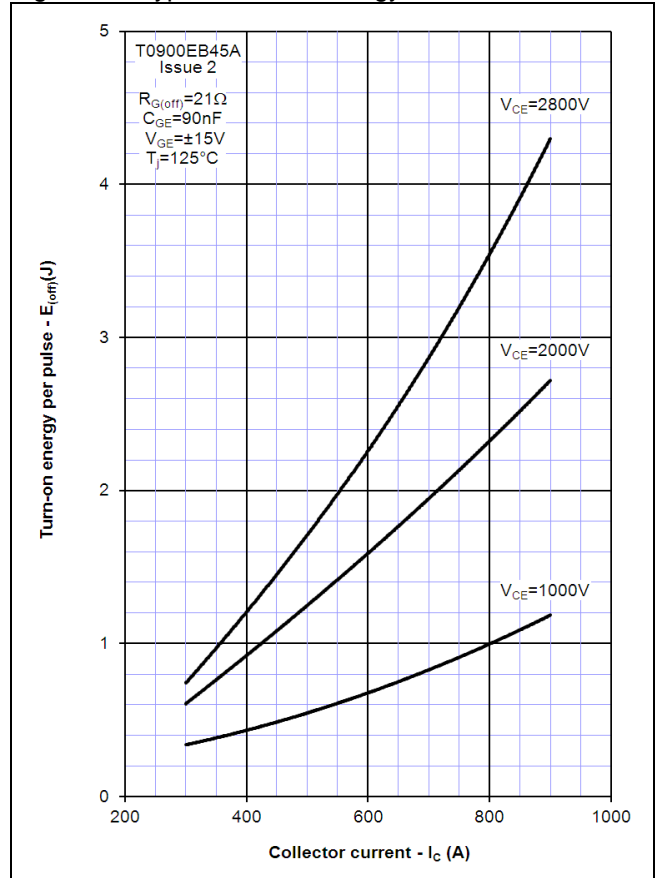


Figure 9 – Turn-off energy vs voltage

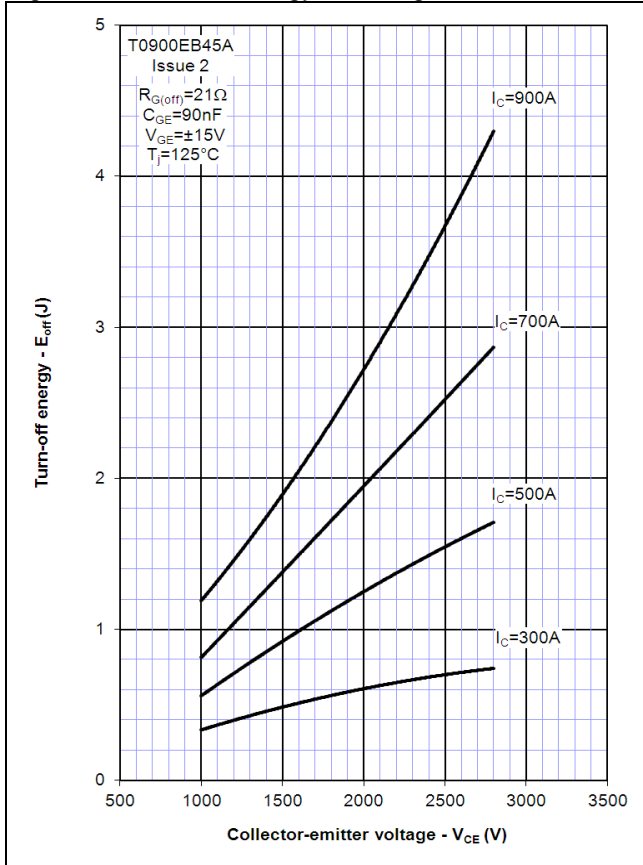


Figure 10 – Safe operating area

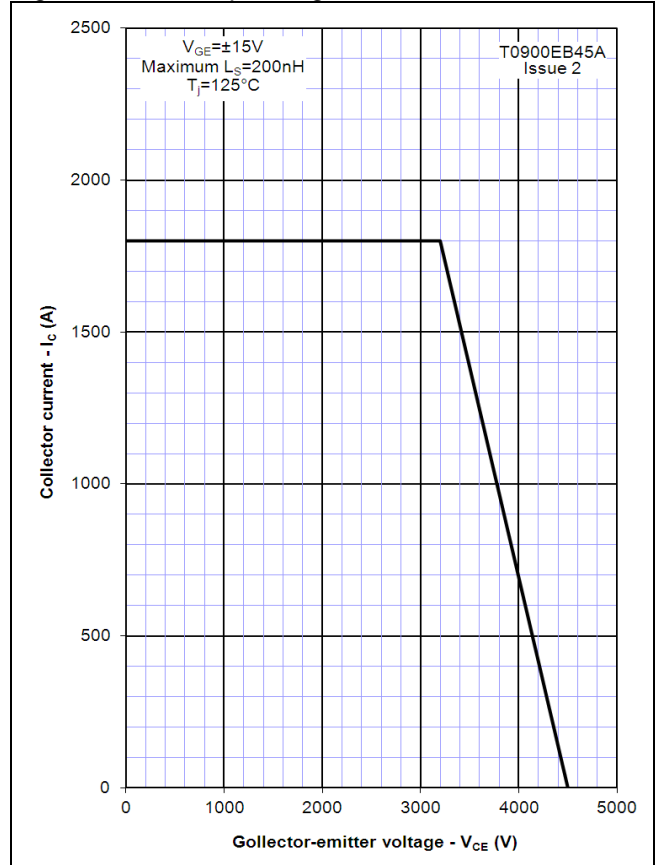


Figure 11 – Typical diode forward characteristics

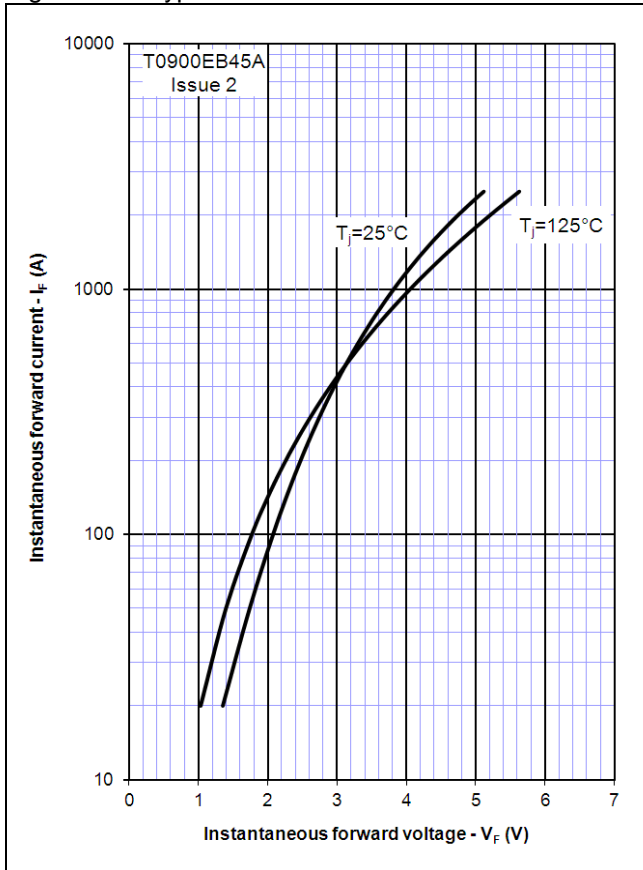


Figure 12 – Typical recovered charge

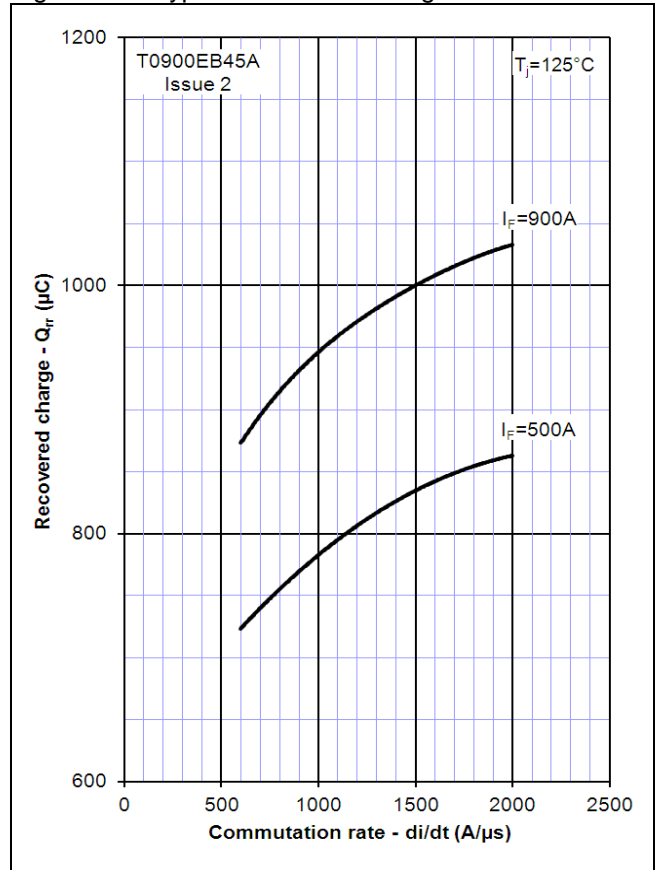


Figure 13 – Typical reverse recovery current

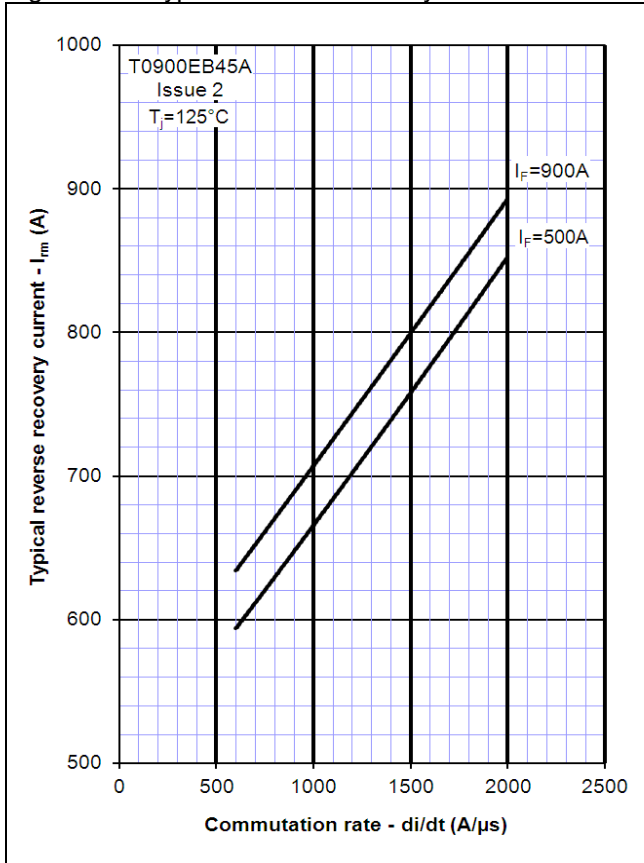


Figure 14 – Typical reverse recovery time

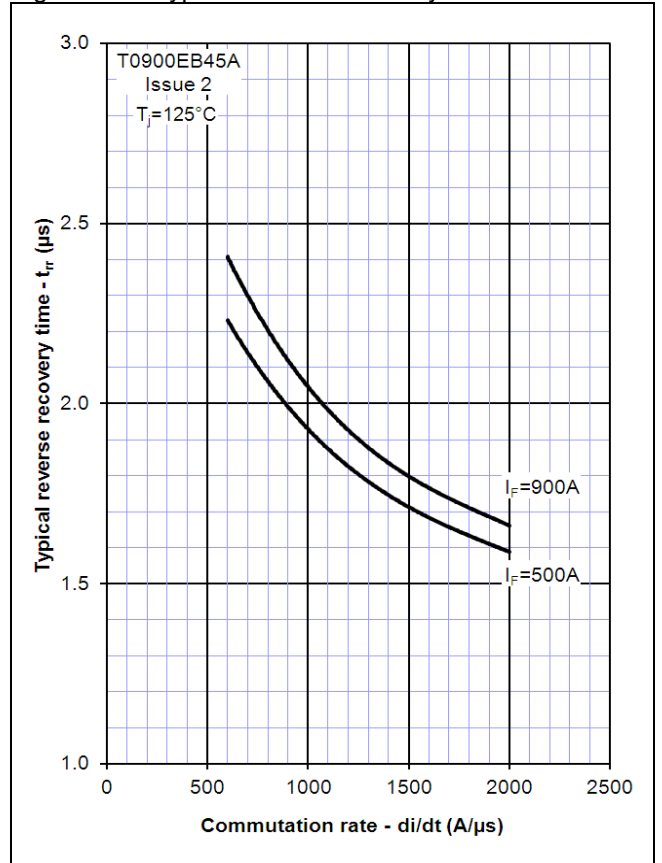


Figure 15 – Typical reverse recovery energy

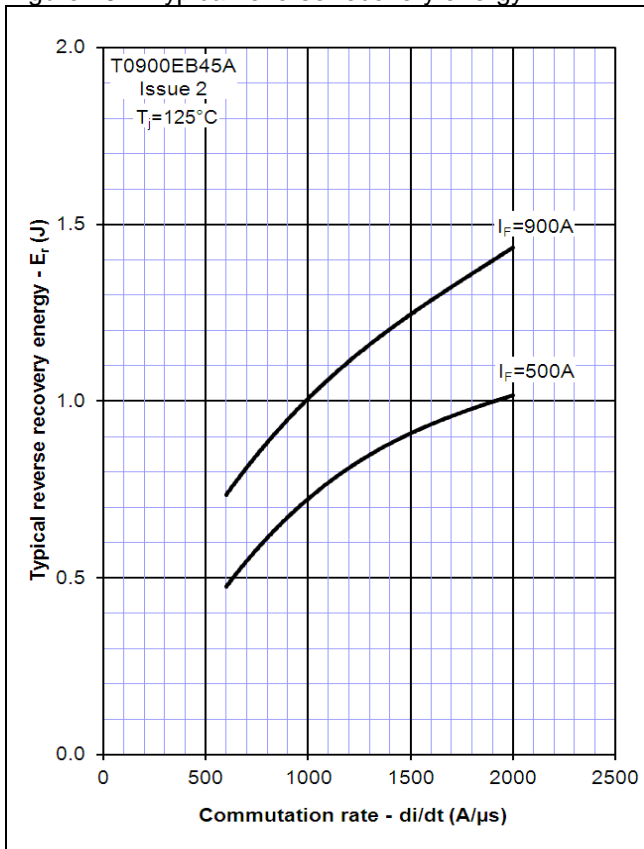


Figure 16 – Safe operating area (Diode)

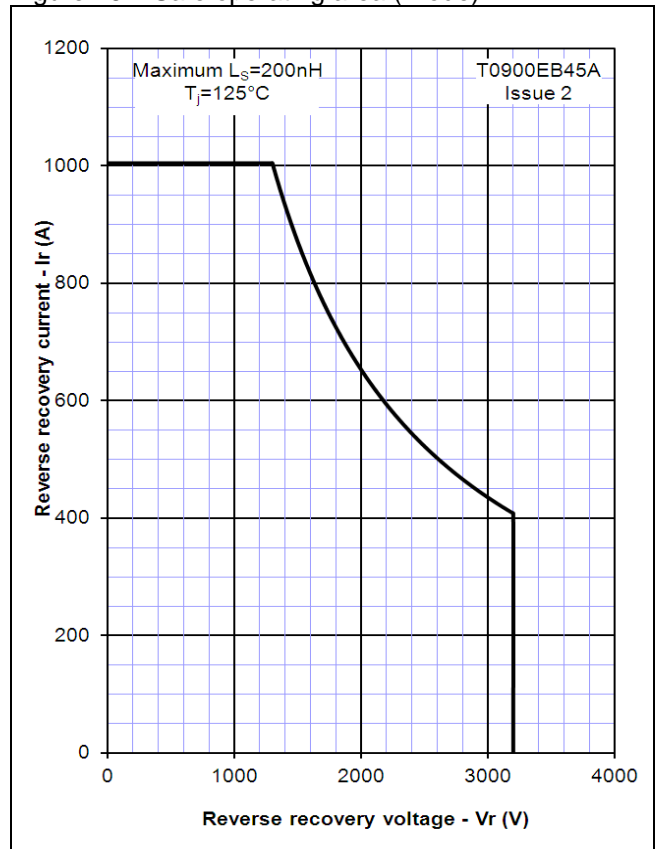


Figure 17 – Transient thermal impedance (IGBT)

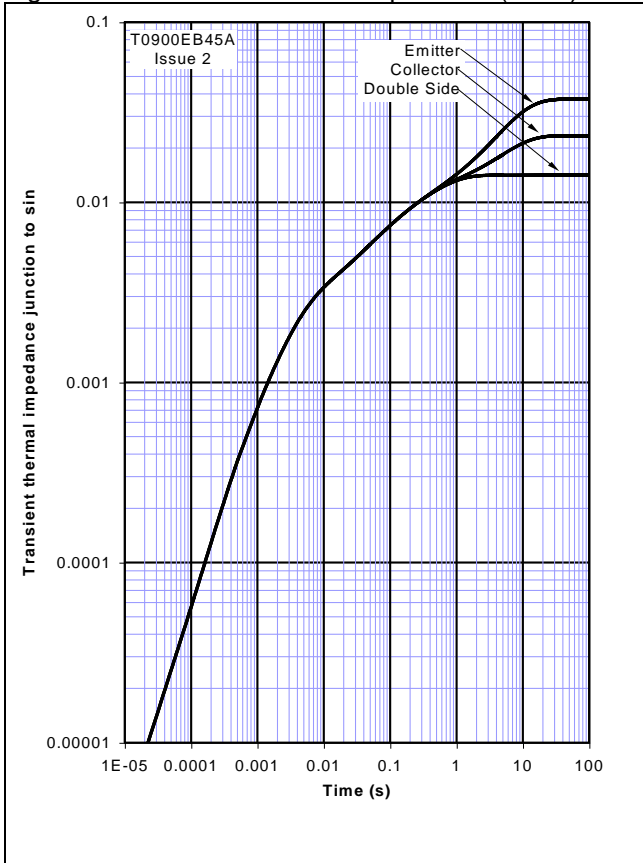
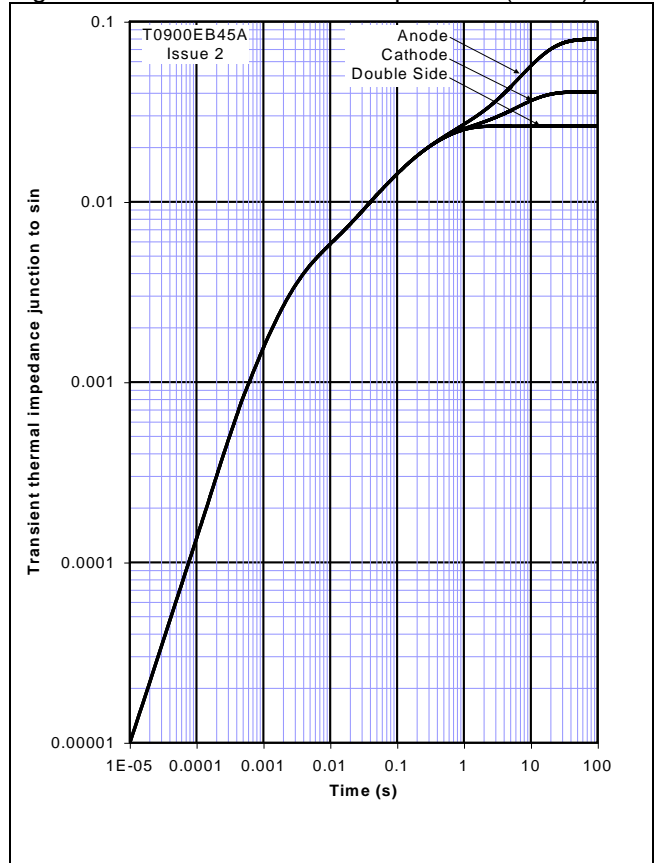
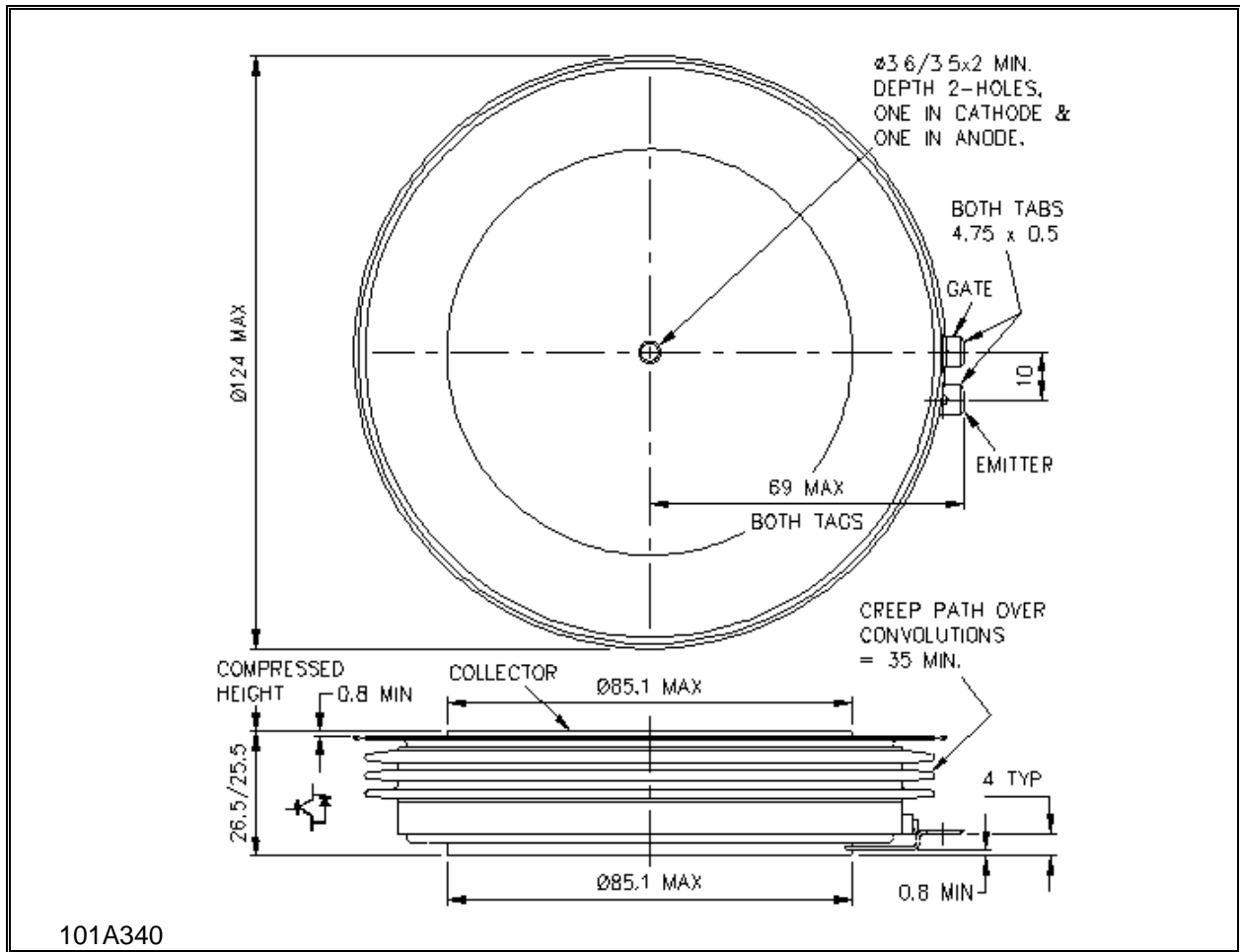


Figure 18 – Transient thermal impedance (Diode)



Outline Drawing & Ordering Information



101A340

ORDERING INFORMATION

(Please quote 10 digit code as below)

| | | | |
|---------------------------------|---------------------------------|---|-------------------------------|
| T0900 Fixed type Code | EB Fixed Outline Code | 45 Voltage Grade $V_{CES}/100$ 45 | A Fixed format code |
|---------------------------------|---------------------------------|---|-------------------------------|

Typical order code: T0900EB45A ($V_{CES} = 4500V$)

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